







		I			2			3			4			
	PRODUCT NUMBER	PRODUCT NUMBER SOLDER BALL COMPOSITION					CONTACT PLATING PERFORMANCE LEVEL							
	10030626-001	STANDARD	(EUTECT	· IC)				LIFIED TO MEET	NI					
	10030626-001LF	LEA		THE REQUIRE GS-12-192,1	N									
А	10030626-201	10030626-201 STANDARD (EUTECTIC)					Au over Ni							
A	10030626-201LF LEADFREE				AU OVET INT								,	
	NOTES:													
			(M.	ATERIAL:				NOTES CONTINUED						
		HOUSING: LCP CONTACT: COPPER ALLOY PLATING (CONTACT): Au OVER Ni. UL RATING: 94 V-O SOLDER BALL: (SEE TABLE) EUTECTIC SnPb OR LEADFREE 95.5 Sn/4Ag/0.5Cu (6) SPECIFIED POSITIONAL TOLERANCE DEFINES PAD TO PAD LOCATION WITHIN LAND PATTERN. POSITIONAL TOLERANCE OF LAND PATTERN TO FUDICIAL MARKS OR PCB DATUMS SHALL BE DEFINED BY CUSTOMER. FOR RECOMMENDED PRODUCT APPLICATION AND PCB DESIGN DETAILS, SEE DOC. NO. GS-20-016.												
В	3 MATED HEIGHT EFFECTED BY CUSTOMERS' PCB PAD SIZE, PLATING, SOLDER REFLOW (2) SOLDER BALLS WILL NOT BE PERFECT SHPERICAL SHAPE DUE TO REFLOW ATTACHMENT. (3) MATED HEIGHT EFFECTED BY CUSTOMERS' PCB PAD SIZE, PLATING, SOLDER REFLOW (4) FOR PROPER APPLICATION FOLLOW FCI APPLICATION SPECIFICATION GS-20-033 LEADFREE SOLDER BALLS WILL NOT SOLDER PROPERLY IN A LEADED SOLDER PROCESS DUE TO A HIGHER REFLOW TEMPERATURE, LEADFREE PRODUCT IS THERFORE NOT BACKWARDS COMPATIBLE WITH LEADED OR SOME SOLDERING APPLICATIONS. REFERENCE FCI APPLICATION													
	PROFILE & SOLDER PASTE. SPECIFICATION. 8) THIS PRODUCT MEETS THE EUROPEAN UNION A) CONTACTS IN ROWS A,C,E,G,J,K,M,P,R AND T DIRECTIVES AND OTHER COUNTRY REGULATIONS AS DESCRIBED.													
W			AR TY	E SINGLE B PICALLY US OTE: CONTA	EAM CONTACTS, ED AS GROUND F CTS IN ROWS J	DINECTIVES AND O			PRODUCT MEETING THE LOT CODE NUI	WITH THE MBER MARK	S DIRECTIVE IS ED ON EACH	Ŝ		
C			AR	E DUAL BEA	ROWS B,D,F,H, M CONTACTS, ED AS SIGNAL F		ID S						(
	spec ref - tolerance std				dr Louis Ng enq Nickor Zuo		2010/11/01	projection	mm)	size A4	scale :	=	
	TOLERANCE			UNLESS	9		2011/06/24		-	—			X-DG-003943-1	
D	-	ASME YI4.5 OTHERWISE SPECIFIED					2011/06/27	product family	GIG-	- Array	rel level	Rele	eased	
	surface	linear	0.X 0.XX	±0.30 ±0.10			G-Array			ои б м р		26	rev	
		V	0.XXX 0°	±0.05 ±2°				'. 200 SIG. PC	, , ,		. Dr	shoot 5 -	E .	
l	Pro/E File - REV C - 2009-06-09	angular		<u> </u> ±2	www.TCI.COM	T cat. no) , 		Product - Cu	1 S T OME I	Drw	sheet 5 o	T 0	
		1	I		2		I	3	PDS: Rev :E	STA	TUS:Released	Printed:	Jun 27, 2011	

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